# **ON Semiconductor**

## Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

# Trench-based Schottky Diode, 100 mA, 30 V

# **NSR01301MX4**

These Trench Schottky diodes are optimized for low forward voltage drop and low leakage current that offers the most optimal power dissipation in applications. They are housed in space saving micro-packaging ideal for space constrained applications.

#### **Features**

- Smallest Package Available (01005); 0.445mm x 0.24mm
- 100 mA of Continuous Forward Current
- Low Forward Voltage Drop 450 mV (Typical) @  $I_F = 100 \text{ mA}$
- Low Reverse Current 0.04  $\mu$ A (Typical) @  $V_R = 30 \text{ V}$
- Very Low Reverse Recovery Time 8 ns Maximum
- Low Capacitance 20 pF Typical

## **Typical Applications**

- Mobile and Wearable Devices
- Camera Photo Flash
- Buck and Boost DC-DC Converters
- Reverse Current Protection
- Clamping & Protection

## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Forward Current (DC)	I <sub>F</sub>	100	mA
Reverse Voltage	V <sub>R</sub>	30	V
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)	I <sub>FRM</sub>	1.0	Α
ESD Rating: Human Body Model Machine Model	ESD	>8.0 >400	kV V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



## ON Semiconductor®

www.onsemi.com



#### MARKING DIAGRAM



X4DFN2 (01005) CASE 718AA



F = Specific Device Code

M = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NSR01301MX4T5G	X4DFN2 (Pb-Free)	10000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### NSR01301MX4

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>θJA</sub> P <sub>D</sub>	614.9 203	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>6JA</sub> P <sub>D</sub>	239.4 522	°C/W mW
Junction Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Lead Solder Temperature - Maximum (10 seconds)	TL	260	°C

- 1. Mounted onto a 4 in<sup>2</sup> FR-4 board 10 mm<sup>2</sup> 1 oz. Cu 0.06' thick single-sided. Operating to steady state.
- 2. Mounted onto a 4 in<sup>2</sup> FR-4 board 2 cm<sup>2</sup> 1 oz. Cu 0.06' thick single-sided. Operating to steady state.

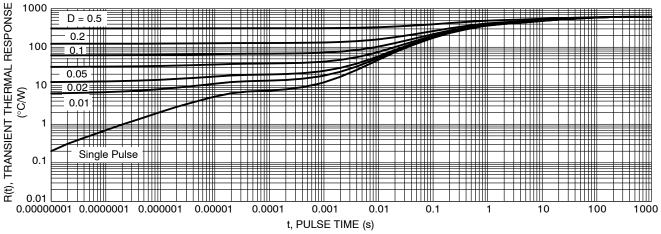


Figure 1. Thermal Response (Note 1)

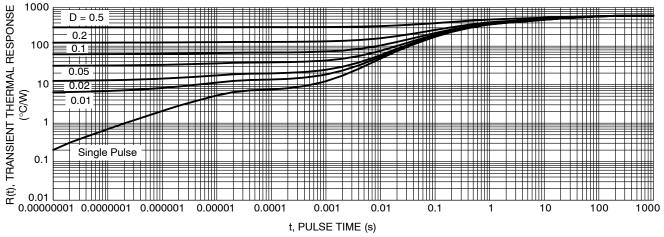


Figure 2. Thermal Response (Note 2)

#### NSR01301MX4

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage (V <sub>R</sub> = 10 V) (V <sub>R</sub> = 30 V)	I <sub>R</sub>		0.02 0.04	4.0 20	μA
Forward Voltage (I <sub>F</sub> = 10 mA) (I <sub>F</sub> = 50 mA) (I <sub>F</sub> = 100 mA)	V <sub>F</sub>		400 420 450	450 470 500	mV
Total Capacitance (V <sub>R</sub> = 5.0 V, f = 1 MHz)	C <sub>T</sub>		20		pF
Reverse Recovery Time $(I_F = I_R = 10 \text{ mA}, I_{R(REC)} = 1.0 \text{ mA})$	t <sub>rr</sub>			8.0	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **TYPICAL CHARACTERISTICS**

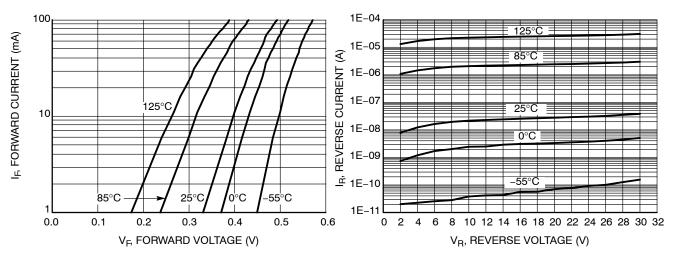


Figure 3. Forward Voltage

Figure 4. Leakage Current

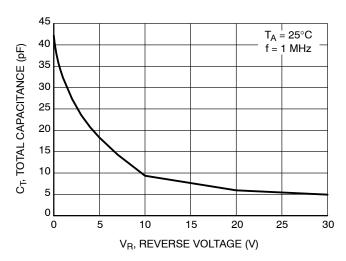
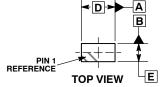


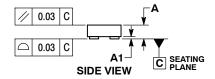
Figure 5. Total Capacitance

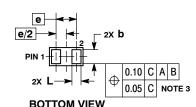
#### X4DFN2, 0.445x0.24, 0.27P CASE 718AA **ISSUE A**



**DATE 21 MAR 2017** 







#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  CONTROLLING DIMENSION: MILLIMETERS.

  EXPOSED COPPER ALLOWED AS SHOWN.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.15	0.18	0.21	
A1			0.03	
b	0.170	0.185	0.200	
D	0.415	0.445	0.475	
Е	0.210	0.240	0.270	
е	0.270 BSC			
L	0.105	0.120	0.135	

#### **GENERIC MARKING DIAGRAMS\***

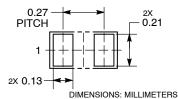




X = Specific Device Code

\*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

#### RECOMMENDED **MOUNTING FOOTPRINT\***



See Application Note AND8398/D for more mounting details

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON29067G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	X4DFN2, 0.445X0.24, 0.27F		PAGE 1 OF 1	

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and the are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and see no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Schottky Diodes & Rectifiers category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

MA4E2503B MA4E2508M-1112 MBR1545CT MMBD301M3T5G RB160M-50TR D83C BAS16E6433HTMA1 BAT 54-02LRH E6327

NRVBAF360T3G NSR05F40QNXT5G NTE555 JANS1N6640 SK310-T SS3003CH-TL-E GA01SHT18 CRS10I30A(TE85L,QM

MA4E2501L-1290 MBRA140TRPBF MBRB30H30CT-1G BAT 15-04R E6152 JANTX1N5712-1 DMJ3940-000 SB007-03C-TB-E

SK33B-TP NRVBB20100CTT4G NRVBM120LT1G NTSB30U100CT-1G VS-6CWQ10FNHM3 CRG04(T5L,TEMQ) ACDBA1100LR-HF

ACDBA1200-HF ACDBA240-HF ACDBA3100-HF CDBQC0530L-HF CDBQC0240LR-HF ACDBA260LR-HF ACDBA1100-HF

MA4E2502L-1246 10BQ015-M3/5BT NRVBM120ET1G CRS08TE85LQM PMAD1108-LF B120Q-13-F 1N5819T-G B0530WSQ-7-F

PDS1040Q-13 B160BQ-13-F SDM05U20CSP-7 B140S1F-7 HSM560Je3/TR13